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Section I. (The Claims)

- (Currently Amended) A cleaning composition including an active cleaning combination 1. (ACC), wherein said ACC consists of a quaternary base, in combination with at least one of alkali and or alkaline earth base, and at least one additional component selected from the group consisting of a chelator, an oxirane species, and combinations thereof, wherein said chelator comprises a species selected from the group consisting of: 1-amino-1,2,4-triazole; 1-amino-1,2,3triazole; 1-amino-5-methyl-1,2,3-triazole; 3-amino-1,2,4-triazole; 3-mercapto-1,2,4-triazole; 3isopropyl-1,2,4-triazole; naphthotriazole; 2-mercaptobenzoimidazole; 2-mercaptobenzothiazole; 5-amino-1,3,4-thiadiazole-2-thiol; 2,4-diamino-6-methyl-1,3,5-triazine; 5-aminotetrazole; thiazole; triazine; methyltetrazole; 1,3-dimethyl-2-imidazolidinone; 1,5-pentamethylenetetrazole; 1-phenyl-5-mercaptotetrazole; diaminomethyltriazine; mercaptobenzothiazole; imidazoline thione; 4-methyl-4H-1,2,4-triazole-3-thiol; 5-amino-1,3,4-thiadiazole-2-thiol; benzothiazole; tritolyl phosphate; indiazole; adenine; thioglycerol; salicylamide; iminodiacetic acid; benzoguanamine; melamine; thiocyranuric acid; anthranilic acid; 3-mercaptopropanol; and combinations thereof, and said cleaning composition is useful for removing photoresist and/or sacrificial anti-reflective coating (SARC) materials from a substrate having such material(s) thereon.
- 2. (Original) The cleaning composition of claim 1, which is devoid of hydroxylamine therein.
- 3. (Cancelled)
- 4. (Previously Presented) The cleaning composition of claim 1, comprising the following components:
 - 0.1 40.0 weight % organic quaternary base;
 - 0.01-5 weight % alkali or alkaline earth base;
 - 0-80 weight % solvent(s) and/or amine(s);
 - 0-5 weight % surfactant;
 - 0-10 weight % chelator/passivation agent; and
 - 0-98 weight % water,

wherein percentages of the components are percentages by weight, based on total weight of the composition, and wherein the total of the weight percentages of such components of the

composition does not exceed 100 weight %.

- 5. (Previously Presented) The cleaning composition of claim 1, including at least one additional ingredient selected from the group consisting of stabilizers, dispersants, anti-oxidants, fillers, penetration agents, adjuvants, additives, and excipients.
- 6. (Previously Presented) The cleaning composition of claim 1, comprising the following components:
 - 2-15 weight % organic quaternary base;
 - ~0.01-2 weight % alkali or alkaline earth base;
 - 0-50 weight % solvent(s) and/or amine(s);
 - ~0.01-2 weight % surfactant;
 - 0-5 weight % chelator/passivation agent; and
 - 40 95 weight % water,

wherein percentages of the components are percentages by weight, based on total weight of the composition, and wherein the total of the weight percentages of such components of the composition does not exceed 100 weight %.

7. (Previously Presented) A cleaning composition selected from the group consisting of Formulations A-C², wherein all percentages are by weight, based on the total weight of the formulation:

Formulation A

- 5.36% benzyltrimethylammonium hydroxide
- 0.28% potassium hydroxide
- 3.0% 4-methylmorpholine N-oxide
- 0.30% polyoxyethylene(150) dinonylphenyl ether
- 0.08% 2-mercaptobenzimidazole
- 91.0% water

Formulation B

- 5.36% benzyltrimethylammonium hydroxide
- 0.28% potassium hydroxide
- 3.0% 4-methylmorpholine N-oxide
- 0.30% polyoxyethylene(150) dinonylphenyl ether
- 0.20% 5-amino-1,3,4-thiadiazole-2-thiol
- 90.86% water

Formulation C

3.60% benzyltrimethylammonium hydroxide

0.27% potassium hydroxide

3.5% 4-methylmorpholine N-oxide

15.0% 4-(3-aminopropyl)morpholine

0.30% polyoxyethylene(150) dinonylphenyl ether

0.08% 2-mercaptobenzimidazole

77.25% water

Formulation D

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

20.0% dimethyl sulfoxide

0.08% 2-mercaptobenzimidazole

74.28% water

Formulation E

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

10.0% tetramethylene sulfone

0.30% oxirane, methyl-, polymer with oxirane, ether with 2,2'-(oxidoimino)bis(ethanol) (2:1), N(-3(C9-11-isoalkyloxy)propyl)derivatives, C₁₀-rich

0.08% 2-mercaptobenzimidazole

83.98% water

Formulation F.

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

10.0% di(ethyleneglycol)butyl ether

10.0% 2-(2-dimethylamino)ethoxy)ethanol

0.30% oxirane, methyl-, polymer with oxirane, ether with 2,2'-(oxidoimino)bis(ethanol) (2:1), N(-3(C9-11-isoalkyloxy)propyl)derivatives, C₁₀-rich

74.06% water

Formulation G

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

10.0% tetramethylene sulfone

10.0% di(ethyleneglycol)butyl ether

0.10% oxirane, methyl-, polymer with oxirane, mono(octylphenyl)ether

0.08% 2-mercaptobenzimidazole

74.18% water,

Formulation H

benzyltrimethylammonium hydroxide, 40% aqueous solution potassium hydroxide, 45% aqueous solution

9.0 %

0.6 %

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N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole aminopropylmorpholine water	7.0 % 4.3 % 0.1 % 20.0 % 59.02 %
Formulation I	
benzyltrimethylammonium hydroxide, 40% aqueous solution potassium hydroxide, 45% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole aminopropylmorpholine water	9.0 % 0.6 % 7.0 % 4.3 % 0.1 % 15.0 % 64.02 %
Formulation J	
benzyltrimethylammonium hydroxide, 40% aqueous solution potassium hydroxide, 45% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole aminopropylmorpholine water	9.0 % 0.6 % 7.0 % 4.3 % 0.1 % 10.0 % 69.02 %
Formulation K	
benzyltrimethylammonium hydroxide, 40% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	13.4 % 7.0 % 0.6 % 0.08 % 0.3 % 78.62 %
Formulation L	
benzyltrimethylammonium hydroxide, 40% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	13.4 % 7.0 % 1.2 % 0.08 % 0.3 % 78.02 %
Formulation M	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene	5.85 % 7.0 % 1.2 % 0.08 % 0.3 %

water

water

Docket No.: 020732-97.668 (7493) Appl. No. 10/792,038 85.57 % 2.93 % tetramethylammonium hydroxide, 25% aqueous solution 7.0 %

1.2 %

0.08 %

0.3 %

88.49 %

Formulation	O

Formulation N

KOH, 45% aqueous solution

dinonylphenol polyoxyethylene

2-mercaptobenzimidizole

N-methylmorpholine oxide, 50% aqueous solution

benzyltrimethylammonium hydroxide, 40% aqueous solution	7.2 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
KOH, 45% aqueous solution	0.6 %
2-mercaptobenzimidizole	0.08 %
•	0.3 %
dinonylphenol polyoxyethylene	84.82 %
water	04.02 70

Formulation P

benzyltrimethylammonium hydroxide, 40% aqueous solution	3.6 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
KOH, 45% aqueous solution	1.2 %
2-mercaptobenzimidizole	0.08 %
dinonylphenol polyoxyethylene	0.3 %
	87.82 %
water	

Formulation Q

benzyltrimethylammonium hydroxide, 40% aqueous solution	3.0 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
KOH, 45% aqueous solution	0.6 %
2-mercaptobenzimidizole	0.08 %
dinonylphenol polyoxyethylene	0.3 %
water	88.42 %

Formulation R

benzyltrimethylammonium hydroxide, 40% aqueous solution	7.2 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
KOH, 45% aqueous solution	0.3 %
2-mercaptobenzimidizole	0.08 %
dinonylphenol polyoxyethylene	0.3 %
	85.12 %,
water	,

Formulation S

benzyltrimethylammonium hydroxide, 40% aqueous solution	22.26 %
Potassium hydroxide, 45% aqueous solution	0.6 %

Appl. No. 10/792,038 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine 1.69 % phosphoric acid (86 %) 1.0 % 3-amino-5-mercapto-1,2,4-triazole 72.04% water Formulation T 22.26 % benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine 1.69 % phosphoric acid (86 %) 1.0 % 4-methyl-2-phenyl-imidazole 72.04 % water Formulation U 22.26% benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6% Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine 1.69 % phosphoric acid (86 %) 1.0 % 2-mercaptothiazoline 72.04 % water Formulation V 22.26% benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine 1.69 % phosphoric acid (86 %) 1.0 % 8-hydroxyquinoline 72.04 % water Formulation W benzyltrimethylammonium hydroxide, 40% aqueous solution 22.26% 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine 1.69 % phosphoric acid (86 %) 1.0 % 1-phenyl-2-tetrazoline-5-thione 72.04 % water Formulation X 22.26 % benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine

1.69 %

phosphoric acid (86 %)

Appl. No. 10/792,038 1.0 % gallic acid 72.04 % water Formulation Y 22.26 % benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine 1.69 % phosphoric acid (86 %) 1.0 % salicylic acid 72.04% water Formulation Z 22.26% benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6% Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 2.33 % methyldiethanolamine 1.69 % phosphoric acid (86 %) 1.0 % ascorbic acid 72.04 % water Formulation A² 7.2 % benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 10 % aminopropyl morpholine 1.0 % 4-methyl-2-phenyl-imidazole 81.12% water Formulation B² 7.2 % benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 10 % aminopropyl morpholine 0.5 % 4-methyl-2-phenyl-imidazole 81.62 % water Formulation C2 benzyltrimethylammonium hydroxide, 40% aqueous solution 7.2 % 0.6% Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 10% aminopropyl morpholine 1.0 % 4-methyl-2-phenyl-imidazole 81.02 % water

wherein said cleaning composition is useful for removing photoresist and/or sacrificial anti-

0.1 %

dinonylphenol polyoxycthylene

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reflective coating (SARC) materials from a substrate having such material(s) thereon.

8. (Currently Amended) A cleaning composition including an active cleaning combination (ACC) and dinonylphenol ethoxylate, wherein said ACC consists of a strong base in combination with an oxidant and said cleaning composition is useful for removing photoresist and/or sacrificial anti-reflective coating (SARC) materials from a substrate having such material(s) thereon.

9. (Currently Amended) The cleaning composition of claim 8, which includes an aqueous solution of at least one oxidant, a strong base, optionally a chelator and/or optionally a co-solvent and/or a surfactant.

10. (Original) The cleaning composition of claim 1, wherein the ACC comprises potassium hydroxide.

11. (Original) The cleaning composition of claim 8, including the following components:

0.1-30 wt % strong base;

0.01-30 wt % oxidant;

0-10 wt % chelator:

0-5 wt % surfactant;

0-50 wt % co-solvent; and

20-98.9 wt % deionized water,

wherein percentages of the components are percentages by weight, based on total weight of the composition, and wherein the total of the weight percentages of such components of the composition does not exceed 100 weight %.

- 12. (Previously Presented) The cleaning composition of claim 11, wherein the strong base comprises a base species selected from the group consisting of potassium hydroxide, alkylammonium hydroxides and choline hydroxide.
- 13. (Original) The cleaning composition of claim 8, wherein the oxidant comprises an oxidant species selected from the group consisting of hydrogen peroxide, amine-N-oxides, perborate salts, persulfate salts, and combinations of two or more of the foregoing.

- 14. (Currently Amended) The cleaning composition of claim 1, further comprising a wherein the chelator comprises 2-mercaptobenzimidazole.
- 15. (Currently Amended) The cleaning composition of claim [[14]] 1, wherein the chelator is present in an amount greater than about 0.08 wt.%, based on the total weight of the composition comprises a species selected from the group consisting of: triazoles; triazoles substituted with substituent(s) selected from the group consisting of C_1 C_8 alkyl, amino, thiol, mercapto, imino, earboxy and nitro; thiazoles; tetrazoles; imidazoles; phosphates; thiols; azines; glycerols; amino aoids; carboxylic acids; alcohols; amides; and quinolines.
- 16. (Cancelled)
- 17. (Previously Presented) The composition of claim 1, further comprising a surfactant.
- 18. (Original) The composition of claim 17, wherein the surfactant comprises a surfactant species selected from the group consisting of: fluoroalkyl surfactants; polyethylene glycols; polypropylene glycols; polyethylene glycol ethers; polypropylene glycol ethers; carboxylic acid salts; dodecylbenzenesulfonic acid and salts thereof; polyacrylate polymers; dinonylphenyl polyoxyethylene; silicone polymers; modified silicone polymers; acetylenic diols; modified acetylenic diols, alkylammonium salts; modified alkylammonium salts; and combinations of two or more of the foregoing.
- 19. (Previously Presented) The composition of claim 1, further comprising a co-solvent.
- 20. (Original) The composition of claim 19, wherein the co-solvent comprises a co-solvent species selected from the group consisting of: amines; glycols; glycol ethers; polyglycol ethers; and combinations of two or more of the foregoing.
- (Original) The composition of claim 19, wherein the co-solvent comprises a co-solvent 21. dimethyldiglycolamine; of: from group consisting selected species diazabicyclo[5.4.0]undccene; aminopropylmorpholine; triethanolamine; methylethanolamine; hydroxyethylmorpholine; glycol; glycol; neopentyl glycol; propylene diethylene aminopropylmorpholine; di(cthylene glycol)monoethyl ether; di(propylene glycol)propyl ether; ethylene glycol phenyl ether; di(propylene glycol) butyl ether; butyl carbitol; polyglycol ethers;

and combinations of two or more of the foregoing.

- 22. (Original) The cleaning composition of claim 8, including:
 - 0.1-30 wt % strong base
 - 2-30 wt % oxidant
 - 0-10 wt % chelator
 - 0-5 wt % surfactant
 - 20-98 wt % deionized water

wherein percentages of the components are percentages by weight, based on total weight of the composition, and wherein the total of the weight percentages of such components of the composition does not exceed 100 weight %.

23. (Currently Amended) The cleaning composition of claim 8, selected from the group consisting of Formulations D^2-L^2 D^2-R^2 , wherein all percentages are by weight, based on the total weight of the formulation:

Formulation D²

tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 3-amino-5-mercapto-1,2,4-triazole water	14.7 % 7.0 % 4.3 % 0.1 % 73.9 %
Formulation E ² tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphonol ethoxylate, 7% aqueous solution ammonium tetrathiomolybdate water	14.7 % 7.0 % 4.3 % 0.1 % 73.9 %
Formulation F ² tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole aminopropylmorpholine water	14.7 % 7.0 % 4.3 % 0.1 % 20.0 % 53.9 %

Formulation G²

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tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole N-ethylmorpholine water	14.7 % 7.0 % 4.3 % 0.1 % 20.0 % 53.9 %
Formulation H ²	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole aminoethylpiperidine water	14.7 % 7.0 % 4.3 % 0.1 % 20.0 % 53.9 %
Formulation I ²	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 3-amino-5-mercapto-1,2,4-triazole aminopropylmorpholine water	14.7 % 7.0 % 4.3 % 0.1 % 20.0 % 53.9 %
Formulation J ²	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 3-amino-5-mercapto-1,2,4-triazole aminopropylmorpholine water	14.7 % 7.0 % 4.3 % 0.1 % 10.0 % 63.9 %
Formulation K ²	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole aminopropylmorpholine water	14.7 % 7.0 % 4.3 % 0.1 % 20.0 % 53.9 %
Formulation L ²	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution dinonylphenol ethoxylate, 7% aqueous solution 2-mercaptobenzimidazole aminopropylmorpholine water	14.7 % 7.0 % 4.3 % 0.1 % 10.0 % 63.9 %

Formulation M ²	
tetramethylammonium hydroxide, 25% aqueous solution -	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
5 aminotetrazole	0.1 %
water	93.9 %
water	
Formulation N ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
2,4-diamino-6-methyl-1,3,5-triazine	— ——0.1 %
water	93.9 %
Formulation O ²	
tetramethylammonium hydroxide, 25% aqueous solution—	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
5-amino-1,3,4 thiadiazole-2 thiol	0.1 %
water-	93.9 %
Formulation P ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	 2.0 %
1.2.4 triazole	
water	93.9 %
Formulation Q ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
2,4 dihydroxy 6 methylpyrimidine	0.1 %
water	93.9 %
Formulation R ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
8-hydroxyquinoline —	0.1 %
water	93.9 %

24. (Withdrawn) A method of removing photoresist and/or SARC material from a substrate having said material thereon, said method comprising contacting the substrate with a cleaning composition for sufficient time to at least partially remove said material from the substrate, wherein the cleaning composition includes an active cleaning combination (ACC) consisting of a quaternary base, in combination with at least one of alkali and or alkaline earth base, and at least

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one additional component selected from the group consisting of a chelator, an oxirane species, and combinations thereof, wherein said chelator comprises a species selected from the group consisting of: 1-amino-1.2,4-triazole; 1-amino-1,2,3-triazole; 1-amino-5-methyl-1,2,3-triazole; 3-amino-1,2,4-triazole; 3-mercapto-1,2,4-triazole; 3-isopropyl-1,2,4-triazole; naphthotriazole; 2-mercaptobenzothiazole; 5-aminotetrazole; 5-amino-1,3,4-thiadiazole-2-thiol; 2,4-diamino-6-methyl-1,3,5-triazine; thiazole; triazine; methyltetrazole; 1,3-dimethyl-2-imidazolidinone; 1,5-pentamethylenetetrazole; 1-phenyl-5-mercaptotetrazole; diaminomethyltriazine; mercaptobenzothiazole; imidazoline thione; 4-methyl-4H-1,2,4-triazole-3-thiol; 5-amino-1,3,4-thiadiazole-2-thiol; benzothiazole; tritolyl phosphate; indiazole; adenine; thioglycerol; salicylamide; iminodiacetic acid; benzoguanamine; melamine; thiocyranuric acid; anthranilic acid; 3-mercaptopropanol; and combinations thereof.

- 25. (Withdrawn) The method of claim 24, wherein the substrate comprises a semiconductor device structure.
- 26. (Withdrawn) The method of claim 24, wherein the material comprises photoresist.
- 27. (Withdrawn) The method of claim 24, wherein the material comprises SARC material.
- 28. (Withdrawn) The method of claim 27, wherein the SARC material has been applied to a semiconductor device structure to minimize reflectivity variations during photolithographic patterning on the semiconductor device structure.
- 29. (Withdrawn) The method of claim 24, wherein said contacting is carried out for a time of from about 10 to about 45 minutes.
- 30. (Withdrawn) The method of claim 24, wherein said contacting is carried out at temperature in a range of from about 50°C to about 80°C.
- 31. (Withdrawn) The method of claim 24, wherein the composition is devoid of hydroxylamine therein.
- 32. (Cancelled)

- 33. (Withdrawn) The method of claim 24, wherein the composition comprises the following components:
 - 0.1 40.0 weight % organic quaternary base;
 - 0.01-5 weight % alkali or alkaline earth base;
 - 0-80 weight % solvent(s) and/or amine(s);
 - 0-5 weight % surfactant;
 - 0-10 weight % chelator/passivation agent; and
 - 0 98 weight % water,

wherein percentages of the components are percentages by weight, based on total weight of the composition, and wherein the total of the weight percentages of such components of the composition does not exceed 100 weight %.

- 34. (Withdrawn) The method of claim 24, wherein the composition includes at least one additional ingredient selected from the group consisting of stabilizers, dispersants, anti-oxidants, fillers, penetration agents, adjuvants, additives, fillers, and excipients.
- 35. (Withdrawn) The method of claim 24, wherein the composition comprises the following components:
 - 2-15 weight % organic quaternary base;
 - ~0.01-2 weight % alkali or alkaline earth base;
 - 0-50 weight % solvent(s) and/or amine(s);
 - ~0.01-2 weight % surfactant;
 - 0-5 weight % chelator/passivation agent; and
 - 40 95 weight % water,

wherein percentages of the components are percentages by weight, based on total weight of the composition, and wherein the total of the weight percentages of such components of the composition does not exceed 100 weight %.

36. (Withdrawn) A method of removing photoresist and/or SARC material from a substrate having said material thereon, said method comprising contacting the substrate with a cleaning composition for sufficient time to at least partially remove said material from the substrate, wherein the cleaning composition is selected from the group consisting of Formulations A-C², wherein all percentages are by weight, based on the total weight of the formulation:

Formulation A

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

3.0% 4-methylmorpholine N-oxide

0.30% polyoxyethylene(150) dinonylphenyl ether

0.08% 2-mercaptobenzimidazole

91.0% water

Formulation B

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

3.0% 4-methylmorpholine N-oxide

0.30% polyoxyethylene(150) dinonylphenyl ether

0.20% 5-amino-1,3,4-thiadiazole-2-thiol

90.86% water

Formulation C

3.60% benzyltrimethylammonium hydroxide

0.27% potassium hydroxide

3.5% 4-methylmorpholine N-oxide

15.0% 4-(3-aminopropyl)morpholine

0.30% polyoxyethylene(150) dinonylphenyl ether

0.08% 2-mercaptobenzimidazole

77.25% water

Formulation D

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

20.0% dimethyl sulfoxide

0.08% 2-mercaptobenzimidazole

74.28% water

Formulation E

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

10.0% tetramethylene sulfone

0.30% oxirane, methyl-, polymer with oxirane, ether with 2,2'-(oxidoimino)bis(ethanol) (2:1), N(-3(C9-11-isoalkyloxy)propyl)derivatives, C10-rich

0.08% 2-mercaptobenzimidazole

83.98% water

Formulation F

5.36% benzyltrimethylammonium hydroxide

0.28% potassium hydroxide

10.0% di(ethyleneglycol)butyl ether

10.0% 2-(2-dimethylamino)ethoxy)ethanol

0.30% oxirane, methyl-, polymer with oxirane, ether with 2,2'-(oxidoimino)bis(ethanol) (2:1), N(-3(C9-11-isoalkyloxy)propyl)derivatives, C₁₀-rich

74.06% water

Formulation G

5.36% benzyltrimethylammonium hydroxide 0.28% potassium hydroxide

10.0% tetramethylene sulfone

10.0% di(ethyleneglycol)butyl ether

0.10% oxirane, methyl-, polymer with oxirane, mono(octylphenyl)ether

0.08% 2-mercaptobenzimidazole

74.18% water,

Formulation H

benzyltrimethylammonium hydroxide, 40% aqueous solution	9.0 %
potassium hydroxide, 45% aqueous solution	0.6 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
dinonylphenol ethoxylate, 7% aqueous solution	4.3 %
2-mercaptobenzimidazole	0.1 %
aminopropylmorpholine	20.0 %
•	59.02 %
water	• • • • • • •

Formulation I

benzyltrimethylammonium hydroxide, 40% aqueous solution	9.0 %
potassium hydroxide, 45% aqueous solution	0.6 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
dinonylphenol ethoxylate, 7% aqueous solution	4.3 %
2-mercaptobenzimidazole	0.1 %
aminopropylmorpholine	15.0 %
• • •	64.02 %
water	0

Formulation J

benzyltrimethylammonium hydroxide, 40% aqueous solution	9.0 %
potassium hydroxide, 45% aqueous solution	0.6 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
dinonylphenol ethoxylate, 7% aqueous solution	4.3 %
2-mercaptobenzimidazole	0.1 %
aminopropylmorpholine	10.0 %
water	69.02 %

Formulation K

benzyltrimethylammonium hydroxide, 40% aqueous solution	13.4 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
KOH, 45% aqueous solution	0.6 %
2-mercaptobenzimidizole	0.08 %

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dinonylphenol polyoxyethylene water	0.3 % 78.62 %
Formulation L	
benzyltrimethylammonium hydroxide, 40% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	13.4 % 7.0 % 1.2 % 0.08 % 0.3 % 78.02 %
Formulation M	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	5.85 % 7.0 % 1.2 % 0.08 % 0.3 % 85.57 %
Formulation N	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	2.93 % 7.0 % 1.2 % 0.08 % 0.3 % 88.49 %
Formulation O	
benzyltrimethylammonium hydroxide, 40% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	7.2 % 7.0 % 0.6 % 0.08 % 0.3 % 84.82 %
Formulation P	
benzyltrimethylammonium hydroxide, 40% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	3.6 % 7.0 % 1.2 % 0.08 % 0.3 % 87.82 %
Formulation Q	
benzyltrimethylammonium hydroxide, 40% aqueous solution	3.6 %

N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	7.0 % 0.6 % 0.08 % 0.3 % 88.42 %
Formulation R	7.0.0/
benzyltrimethylammonium hydroxide, 40% aqueous solution N-methylmorpholine oxide, 50% aqueous solution KOH, 45% aqueous solution 2-mercaptobenzimidizole dinonylphenol polyoxyethylene water	7.2 % 7.0 % 0.3 % 0.08 % 0.3 % 85.12 %,
Formulation S	
benzyltrimethylammonium hydroxide, 40% aqueous solution Potassium hydroxide, 45% aqueous solution 2-mercaptobenzimidazole methyldiethanolamine phosphoric acid (86%) 3-amino-5-mercapto-1,2,4-triazole water	22.26 % 0.6 % 0.08 % 2.33 % 1.69 % 1.0 % 72.04 %
Formulation T	
benzyltrimethylammonium hydroxide, 40% aqueous solution Potassium hydroxide, 45% aqueous solution 2-mercaptobenzimidazole methyldiethanolamine phosphoric acid (86%) 4-methyl-2-phenyl-imidazole water	22.26 % 0.6 % 0.08 % 2.33 % 1.69 % 1.0 % 72.04 %
Formulation U	
benzyltrimethylammonium hydroxide, 40% aqueous solution Potassium hydroxide, 45% aqueous solution 2-mercaptobenzimidazole methyldiethanolamine phosphoric acid (86 %) 2-mercaptothiazoline water	22.26 % 0.6 % 0.08 % 2.33 % 1.69 % 1.0 % 72.04 %
Formulation V	
benzyltrimethylammonium hydroxide, 40% aqueous solution Potassium hydroxide, 45% aqueous solution 2-mercaptobenzimidazole methyldiethanolamine phosphoric acid (86 %) 8-hydroxyquinoline	22.26 % 0.6 % 0.08 % 2.33 % 1.69 % 1.0 %

	72.04.9/
water	72.04 %
Formulation W	
benzyltrimethylammonium hydroxide, 40% aqueous solution	22.26 %
Potassium hydroxide, 45% aqueous solution	0.6 %
2-mercaptobenzimidazole	0.08 %
methyldiethanolamine	2.33 %
phosphoric acid (86 %)	1.69 %
1-phenyl-2-tetrazoline-5-thione	1.0 %
water	72.04 %
Formulation X	
benzyltrimethylammonium hydroxide, 40% aqueous solution	22.26 %
Potassium hydroxide, 45% aqueous solution	0.6 %
2-mercaptobenzimidazole	0.08 %
methyldiethanolamine	2.33 %
phosphoric acid (86 %)	1.69 %
gallic acid	1.0 %
water	72.04 %
Formulation Y	•
benzyltrimethylammonium hydroxide, 40% aqueous solution	22.26 %
Potassium hydroxide, 45% aqueous solution	0.6 %
2-mercaptobenzimidazole	0.08 %
methyldiethanolamine	2.33 %
phosphoric acid (86 %)	1.69 %
salicylic acid	1.0 %
water	72.04 %
Formulation Z	22.26 %
benzyltrimethylammonium hydroxide, 40% aqueous solution	0.6 %
Potassium hydroxide, 45% aqueous solution	0.08 %
2-mercaptobenzimidazole	2.33 %
methyldiethanolamine	1.69 %
phosphoric acid (86 %)	1.0 %
ascorbic acid	72.04 %
water	72.04 76
Formulation A ²	
benzyltrimethylammonium hydroxide, 40% aqueous solution	7.2 %
Potassium hydroxide, 45% aqueous solution	0.6 %
2-mercaptobenzimidazole	0.08 %
aminopropyl morpholine	10 %
4-methyl-2-phenyl-imidazole	1.0 %
water	81.12 %
Formulation B ²	
benzyltrimethylammonium hydroxide, 40% aqueous solution	7.2 %

Docket No.: 020732-97.668 (7493) Appl. No. 10/792,038 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 10 % aminopropyl morpholine 0.5 % 4-methyl-2-phenyl-imidazole 81.62 % water Formulation C² 7.2 % benzyltrimethylammonium hydroxide, 40% aqueous solution 0.6 % Potassium hydroxide, 45% aqueous solution 0.08 % 2-mercaptobenzimidazole 10 % aminopropyl morpholine 1.0 % 4-methyl-2-phenyl-imidazole 81.02 % water 0.1 %. dinonylphenol polyoxyethylene

- 37. (Withdrawn) A method of removing photoresist and/or SARC material from a substrate having said material thereon, said method comprising contacting the substrate with a cleaning composition for sufficient time to at least partially remove said material from the substrate, wherein the cleaning composition includes the active cleaning combination (ACC) of claim 8.
- 38. (Withdrawn) The method of claim 37, wherein the cleaning composition includes an aqueous solution of at least one oxidant, a strong base, optionally a chelator and/or optionally a co-solvent and/or a surfactant.
- 39. (Withdrawn) The method of claim 24, wherein the ACC comprises potassium hydroxide.
- 40. (Withdrawn) The method of claim 37, wherein the cleaning composition includes the following components:
 - 0.1-30 wt % strong base;
 - 0.01-30 wt % oxidant;
 - 0-10 wt % chelator;
 - 0-5 wt % surfactant;
 - 0-50 wt % co-solvent; and
 - 20-98.9 wt % deionized water,

wherein percentages of the components are percentages by weight, based on total weight of the composition, and wherein the total of the weight percentages of such components of the composition does not exceed 100 weight %.

- 41. (Withdrawn) The method of claim 40, wherein the strong base comprises a base species selected from the group consisting of potassium hydroxide and alkylammonium hydroxides and choline hydroxide.
- 42. (Withdrawn) The method of claim 37, wherein the oxidant comprises an oxidant species selected from the group consisting of hydrogen peroxide, amine-N-oxides, perborate salts, persulfate salts, and combinations of two or more of the foregoing.
- 43. (Withdrawn) The method of claim 24, wherein the eleaning composition further comprises a chelator comprises 2-mercaptobenzimidazole.
- 44. (Withdrawn) The method of claim 43, wherein the chelator is present in an amount greater than about 0.08 wt.%, based on the total weight of the composition comprises a species selected from the group consisting of: triazoles; triazoles substituted with substituent(s) selected from the group consisting of C₁ C₈ alkyl, amino, thiol, mercapto, imino, carboxy and nitro; thiazoles; tetrazoles; imidazoles; phosphates; thiols; azines; glycerols; amino acids; carboxylic acids; alcohols; amides; and quinolines.
- (Withdrawn) The method of claim 24, wherein the quaternary base comprises 45. benzyltrimethylammonium hydroxide 43, wherein the chelator comprises a chelator species selected from the group-consisting of: 1,2,4-triazole; benzotriazole; tolyltriazole; 5 phenylbenzotriazole; 5 nitro benzotriazole; 1 amino 1,2,4 triazole; hydroxybenzotriazole; 2 (5 amino pentyl) benzotriazole; 1-amino 1,2,3 triazole; 1-amino 5 methyl 1,2,3 triazole; 3 amino 1,2,4 triazole; 3 mercapto 1,2,4 triazole; 3 isopropyl 1,2,4 triazole; 5 phenylthiol benzotriazole; halobenzotriazoles wherein halo is selected from the group consisting of F, Cl, Br and I; naphthotriazole; 2-mercaptobenzoimidizole; 2-mercaptobenzothiazole; 5-aminotetrazole; 5amino-1,3,4 thiadiazole-2-thiol; 2,4-diamino-6-methyl-1,3,5-triazine; thiazole; triazine; methyltetrazole; 1,3 dimethyl 2 imidazolidinone; 1,5 pentamethylenetetrazole; 1-phenyl-5mercaptotetrazole; -diaminomethyltriazine; mercaptobenzothiazole; imidazoline thione; mercaptobenzimidazole; 4 methyl 4H 1,2,4 triazole 3 thiol; 5 amino 1,3,4 thiadiazole 2 thiol; benzothiazole; trritolyl -- phosphate; indiazole; guanine; -- adenine; -- glycerol; -- thioglycerol; nitrilotriacetic acid; salicylamide; iminodiacetic acid; benzoguanamine; melamine; thiocyranuric acid; anthranilio acid; 8-hydroxyquinoline; 5-carboxylio acid-benzotriazole; 3-mercaptopropanol; boric acid; and iminodiacetic acid.

- 46. (Withdrawn) The method of claim 24, wherein the cleaning composition further comprises a surfactant.
- 47. (Withdrawn) The method of claim 46, wherein the surfactant comprises a surfactant species selected from the group consisting of: fluoroalkyl surfactants; polyethylene glycols; polypropylene glycols; polypropylene glycol ethers; polypropylene glycol ethers; carboxylic acid salts; dodecylbenzenesulfonic acid and salts thereof; polyacrylate polymers; dinonylphenyl polyoxyethylene; silicone polymers; modified silicone polymers; acetylenic diols; modified acetylenic diols, alkylammonium salts; modified alkylammonium salts; and combinations of two or more of the foregoing.
- 48. (Withdrawn) The method of claim 24, wherein the cleaning composition further comprises a co-solvent.
- 49. (Withdrawn) The method of claim 48, wherein the co-solvent comprises a co-solvent species selected from the group consisting of: amines; glycols; glycol ethers; polyglycol ethers; and combinations of two or more of the foregoing.
- (Withdrawn) The method of claim 48, wherein the co-solvent comprises a co-solvent 50. dimethyldiglycolamine; 1,8of: consisting selected from the group species diazabicyclo[5.4.0]undecene; aminopropylmorpholine: triethanolamine; methylethanolamine; hydroxyethylmorpholine; neopentyl glycol; glycol; propylene glycol; diethylene aminopropylmorpholine; di(ethylene glycol)monoethyl ether; di(propylene glycol)propyl ether; ethylene glycol phenyl ether; di(propylene glycol) butyl ether; butyl carbitol; polyglycol ethers; and combinations of two or more of the foregoing.
- 51. (Withdrawn) The method of claim 37, wherein the composition includes:
- 0.1-30 wt % strong base
- 2-30 wt % oxidant
- 0-10 wt % chelator
- 0-5 wt % surfactant
- 20-98 wt % deionized water
- wherein percentages of the components are percentages by weight, based on total weight of the

composition, and wherein the total of the weight percentages of such components of the composition does not exceed 100 weight %.

52. (Withdrawn) The method of claim 37, wherein the cleaning composition is selected from the group consisting of Formulations $\underline{D^2-L^2}$ $\underline{D^2-R^2}$, wherein all percentages are by weight, based on the total weight of the formulation:

Formulation D ²	
tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution	14.7 % 7.0 %
dinonylphenol ethoxylate, 7% aqueous solution	4.3 % 0.1 %
3-amino-5-mercapto-1,2,4-triazole	
water	73.9 %
Formulation E ²	•
tetramethylammonium hydroxide, 25% aqueous solution	14.7 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
N-methylmorpholine oxide, 50% aqueous solution	4.3 %
dinonylphenol ethoxylate, 7% aqueous solution	0.1 %
ammonium tetrathiomolybdate water	73.9 %
Formulation F ²	
	14.7 %
tetramethylammonium hydroxide, 25% aqueous solution	7.0 %
N-methylmorpholine oxide, 50% aqueous solution	4.3 %
dinonylphenol ethoxylate, 7% aqueous solution	0.1 %
2-mercaptobenzimidazole	20.0 %
aminopropylmorpholine 'water	53.9 %
Formulation G ²	
tetramethylammonium hydroxide, 25% aqueous solution	14.7 %
N-methylmorpholine oxide, 50% aqueous solution	7.0 %
dinonylphenol ethoxylate, 7% aqueous solution	4.3 %
2-mercaptobenzimidazole	0.1 %
N-ethylmorpholine	20.0 %
water	53.9 %
Formulation H ²	
	14.7 %
tetramethylammonium hydroxide, 25% aqueous solution	7.0 %
N-methylmorpholine oxide, 50% aqueous solution	4.3 %
dinonylphenol ethoxylate, 7% aqueous solution	0.1 %
2-mercaptobenzimidazole	20.0 %
aminoethylpiperidine	

water -

Appl. No. 10/792,038 53.9 % water Formulation I2 14.7 % tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution 7.0 % 4.3 % dinonylphenol ethoxylate, 7% aqueous solution 0.1% 3-amino-5-1,2,4-triazole 20.0 % aminopropylmorpholine 53.9 % water Formulation J² 14.7% tetramethylammonium hydroxide, 25% aqueous solution 7.0 % N-methylmorpholine oxide, 50% aqueous solution 4.3 % dinonylphenol ethoxylate, 7% aqueous solution 0.1 % 3-amino-5-1,2,4-triazole 10.0 % aminopropylmorpholine 63.9 % water Formulation K² 14.7 % tetramethylammonium hydroxide, 25% aqueous solution 7.0 % N-methylmorpholine oxide, 50% aqueous solution 4.3 % dinonylphenol ethoxylate, 7% aqueous solution 0.1 % 2-mercaptobenzimidazole 20.0 % aminopropylmorpholine 53.9 % water Formulation L² 14.7% tetramethylammonium hydroxide, 25% aqueous solution N-methylmorpholine oxide, 50% aqueous solution 7.0 % 4.3 % dinonylphenol ethoxylate, 7% aqueous solution 0.1 % 2-mercaptobenzimidazole 10.0 % aminopropylmorpholine 63.9 % water Formulation M² tetramethylammonium hydroxide, 25% aqueous solution-20% hydrogen peroxide, 30% aqueous solution 0.1.% 5-aminotetrazole 93.9 % water-Formulation N² tetramethylammonium hydroxide, 25% aqueous solutionhydrogen peroxide, 30% aqueous solution-0.1% 2.4-diamino 6-methyl-1,3,5 triazine

Formulation O ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	_ 2.0 %
5-amino 1,3,4 thiadiazole 2 thiol	0.1 %
	93.9 %
water	
Formulation P ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
1,2,4-triazole	0.1%
water-	93.9 %
Formulation Q ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
2,4 dihydroxy 6 methylpyrimidine	0.1 %
water	93.9 %
Formulation R ²	
tetramethylammonium hydroxide, 25% aqueous solution	4.0 %
hydrogen peroxide, 30% aqueous solution	2.0 %
8 hydroxyquinoline	
	93.9 % .
water	

- 53. (Previously Presented) The cleaning composition of claim 1, wherein the quaternary base comprises an organic quaternary ammonium base.
- 54. (Previously Presented) The cleaning composition of claim 1, wherein the quaternary base comprises benzyltrimethylammonium hydroxide.
- 55. (Previously Presented) The cleaning composition of claim 1, wherein the ACC comprises benzyltrimethylammonium hydroxide and potassium hydroxide.
- 56. (Previously Presented) The cleaning composition of claim 19, wherein the co-solvent comprises a glycol ether.
- 57. (Previously Presented) The cleaning composition of claim 1 comprising benzyltrimethylammonium hydroxide; potassium hydroxide; tetramethylene sulfone;

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di(ethyleneglycol)butyl ether; oxirane, methyl-, polymer with oxirane, mono(octylphenyl)ether; 2-mercaptobenzimidazole; and water.

- 58. (Withdrawn) A method of making a semiconductor device comprising contacting the substrate with the cleaning composition of claim 1 for sufficient time to at least partially remove said material from the substrate.
- 59. (Previously Presented) The cleaning composition of claim 1, further comprising oxidant.